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FDG8850NZ Dual N-Channel PowerTrench[®] MOSFET 30V,0.75A,0.4Ω

Features

- Max $r_{DS(on)}$ = 0.4 Ω at V_{GS} = 4.5V, I_D = 0.75A
- Max $r_{DS(on)}$ = 0.5 Ω at V_{GS} = 2.7V, I_D = 0.67A
- Very low level gate drive requirements allowing operation in 3V circuits(V_{GS(th)} <1.5V)</p>

S2

G2

D1

- Very small package outline SC70-6
- RoHS Compliant



General Description

S1

G1

D2 3

2

This dual N-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETs. Since bias resistors are not required, this dual digital FET can replace several different digital transistors, with different bias resistor values.

SC70-6 Pin 1 MOSFET Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		30	V
V _{GS}	Gate to Source Voltage		±12	V
1	Drain Current -Continuous		0.75	^
D	-Pulsed		2.2	— A
P _D Po	Power Dissipation for Single Operation	(Note 1a)	0.36	14/
		(Note 1b)	0.30	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient Single operation	(Note 1a)	350	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient Single operation	(Note 1b)	415	C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
.50	FDG8850NZ	7"	8mm	3000 units

April 2007

D1

G2

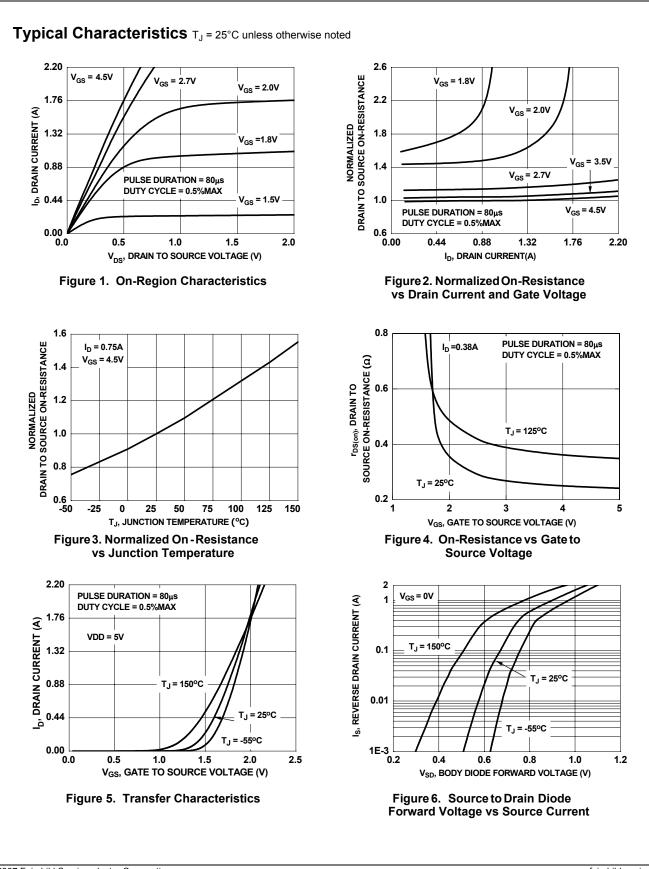
4 S2

6

5

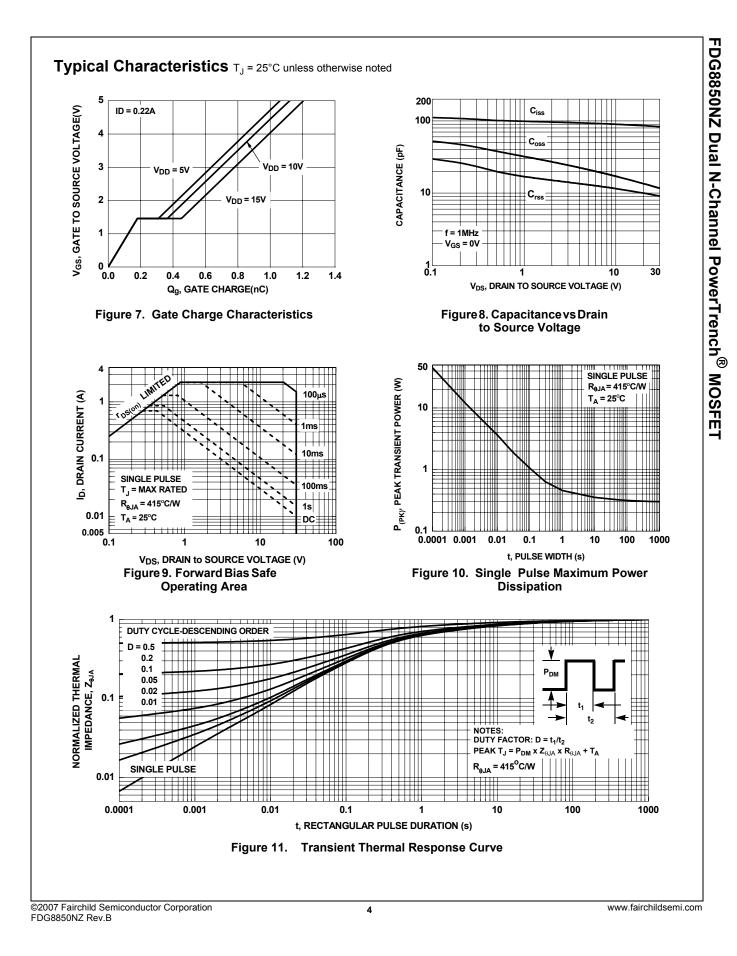
FDG8850NZ Dual
Jual N-Channe
l PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{.1}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		25		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24V, V _{GS} = 0V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 12V, V_{DS} = 0V$			±10	μA
	cteristics		-			1
	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	0.65	1.0	1.5	V
V _{GS(th)}	Gate to Source Threshold Voltage	$v_{GS} - v_{DS}$, $I_D - 250\mu A$	0.05	1.0	1.5	v
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Temperature Coefficient	I_D = 250µA, referenced to 25°C		-3.0		mV/°C
0	•	V _{GS} = 4.5V, I _D = 0.75A		0.25	0.4	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 2.7V, I_{D} = 0.67A$		0.29	0.5	Ω
. ,		$V_{GS} = 4.5V, I_D = 0.75A, T_J = 125^{\circ}C$		0.36	0.6	
9 _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 0.75A$		3		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			90	120	pF
C _{oss}	Output Capacitance	V _{DS} = 10V, V _{GS} = 0V, f= 1MHZ		20	30	pF
C _{rss}	Reverse Transfer Capacitance			15	25	pF
Switching	Characteristics (note 2)					
t _{d(on)}	Turn-On Delay Time			4	10	ns
t _r	Rise Time	V_{DD} = 5V, I _D = 0.5A, V _{GS} = 4.5V,R _{GEN} = 6Ω		1	10	ns
	Turn-Off Delay Time			9	18	ns
t _{d(off)} t _f	Fall Time			1	10	ns
Q _g	Total Gate Charge			1.03	1.44	nC
Q _g Q _{gs}	Gate to Source Charge	V _{GS} =4.5V, V _{DD} = 5V, I _D = 0.75A		0.29	1.44	nC
Q _{gd}	Gate to Drain "Miller" Charge			0.17		nC
	-			0		
-	urce Diode Characteristics and M					
I _S	Maximum Continuous Drain-Source Diode				0.3	A
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 0.3A$ (Note 2)		0.76	1.2	V
Scale	ranteed by design while R _{0JA} is determined by the user's a. 350°C/W when mounted on 1 in ² pad of 2 oz copper. e 1:1 on letter size paper. Pulse Width < 300μs, Duty cycle < 2.0%.			on a minir	num pad	



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DG8850NZ Dual N-Channel PowerTrench[®] MOSFE

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